



Solving MIPI D-PHY Receiver Test Challenges

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Abstract

MIPI stands for the “Mobile Industry Processor Interface”, which provides a flexible, low-cost, high-speed interface solution for communication links between components inside a mobile device. With more than 100 companies backing this emerging standard, MIPI is expected to be widely adopted for smart phones and similar application-rich networked devices, as well as in personal digital assistants (PDAs), and other consumer electronics. ^[1]

While the MIPI D-PHY specification enables significant extension flexibility for various advanced applications, it also creates new test challenges for device manufacturers. Besides the source-synchronous nature of the high-speed data transmission, it is mainly the requirement for providing multi-level signals to the device under test (DUT), which represents the biggest challenge for most automatic test equipment (ATE). This is especially true, since the economic pressure in the consumer electronics marketplace rules out the use of special tester hardware beyond standard digital pins. In this paper we will discuss in detail how three-level signals required for MIPI D-PHY testing can be generated on all standard V93000 Pin Scale digital cards.

Key Words – MIPI, D-PHY, receiver test, multi-level signals, three-level signaling

1. Introduction to MIPI

The Mobile Industry Processor Interface (MIPI) is an increasingly adopted high-speed source synchronous interface for communication links between components inside a mobile device. Due to its flexible, low-cost and high performance nature, it is widely applied for smart phones, rich networked devices, PDAs and other consumer electronics. One most notable aspect of MIPI D-PHY standard is its data transmission modes: besides a low-swing high-speed differential mode for data transmission, it also employs a large-swing low-power single-ended mode for control purposes. Since those two modes differ dramatically in their characteristics, MIPI requires a very flexible test solution to ensure comprehensive test coverage. For MIPI receiver tests, for example, it requires that the equipment is able to generate multi-level signals.

The D-PHY standard ^[2], which communicates on the order of 500 Mbps (the Roman numeral for 500 is “D”), is the initial foundation of MIPI for its camera, display and universal interfaces. D-PHY supports as many as 4 lanes at rates of up to 1 Gbps per lane, based on a source-synchronous, scalable, low-voltage signaling technology. ^[3]

2. Structure of MIPI D-PHY

A complete MIPI physical connection consists of a transmitter (TX), and/or a receiver (RX) at each side, with Transmission-Line-Interconnect-Structure (TLIS) in between. With respect to physical dimensions, the Transmission-Line-Interconnect-Structure will typically be the largest part.

The D-PHY applies a master-slave work mode to the two sides of the links and provides an asymmetrical source synchronous link between them. The master provides the high-speed double data-rate (DDR) clock signal to the clock lane and is the main data source. The slave receives the clock signal at the clock lane and is the main data sink. This direction of communication is denoted as the “forward direction”, while communication in the opposite direction is called “reverse traffic”. A practical PHY configuration consists of a clock signal and one or more data signals. The clock signal, which is compulsory, is unidirectional; originating at the master and terminating at the slave. The data signals can either be unidirectional or bi-directional depending on the selected options. D-PHY uses two wires per data lane plus two wires for the clock lane. This requires four wires for the minimum D-PHY configuration as shown in Figure 1.

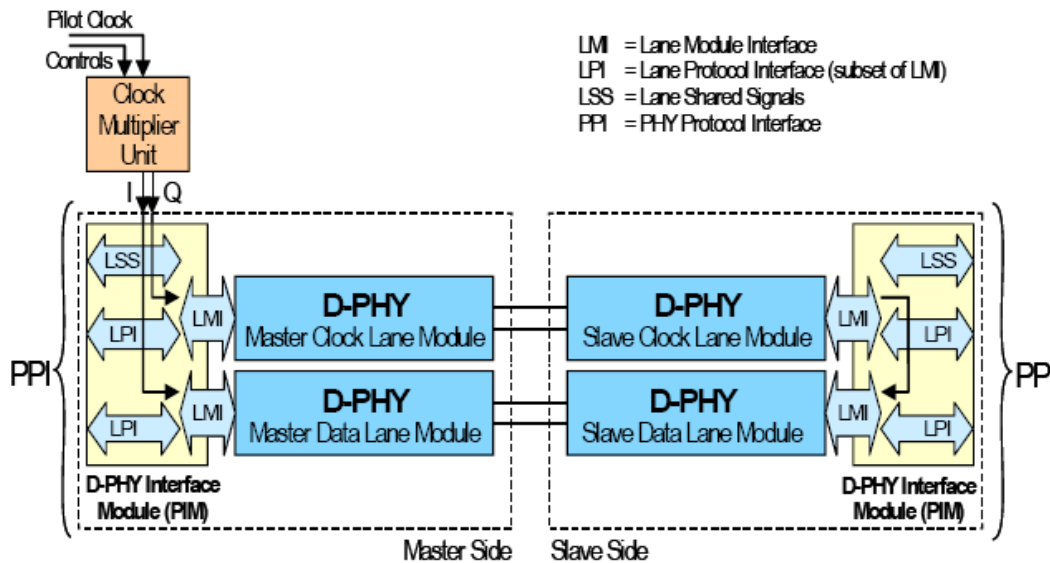


Figure 1: Minimum D-PHY configuration [2]

In the forward direction, data is transmitted in a source synchronous manner. For reverse traffic, which is optional (i.e. only available with bi-directional data lanes), the clock lane remains in a forward direction, but data lane(s) are turned-around, sourcing data from the slave side. The reverse traffic arriving at the master side will not be phase synchronous with the forward direction clock. Reverse transmission by the slave side is one-fourth the forward direction speed, based on the forward direction clock transmitted via the clock lane and therefore a data recovery function is required for reverse direction traffic.

Though the actual maximum achievable bit-rate in high-speed mode is determined by the overall performance of transmitter, receiver and inter-connect implementations, a bit-rate range of 80 to 1000 Mbps per lane is typically defined, whereas the maximum data rate is 10 Mbps in low-power mode.

3. Key characteristics of MIPI signaling

There are two different data transmission modes available; referred to as the high-speed (HS) mode for fast data traffic and the low-power (LP) mode for control purposes. Optionally, the low-power mode can be used for low-speed asynchronous data communication.

The high-speed mode has the following characteristics:

- It includes a differential transmitter (HS-TX) and a differential receiver (HS-RX).
- A lane module may contain a HS-TX, a HS-RX, or both.

- A HS-TX and a HS-RX within a single lane module are never enabled simultaneously during normal operation.
- In high-speed mode each lane is terminated on both sides and driven by a low-swing, differential signal.
- If no high-speed function in the lane module is enabled then the high-speed functions will be put into a high impedance state.

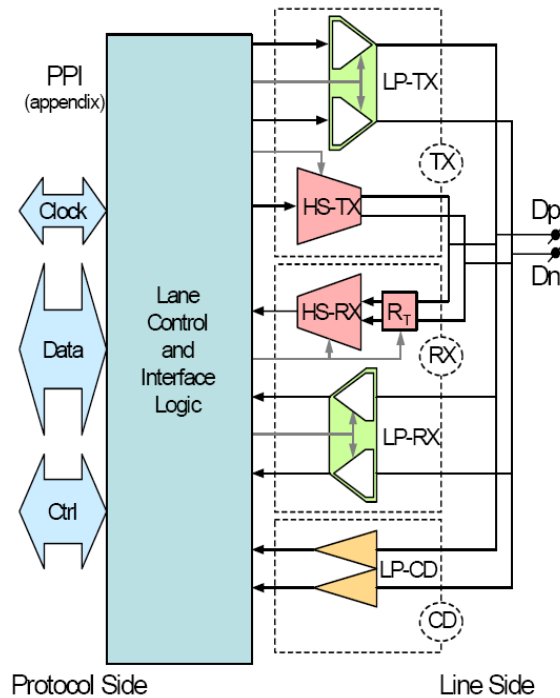


Figure 2: D-PHY universal lane module functions [2]

In contrast, the low-power function, which activates the low-power mode used mainly for control purpose, features the following characteristics:

- It includes single-ended transmitters (LP-TX), receivers (LP-RX) and Low-Power Contention-Detectors (LP-CD).
- The LP transmitter is a push-pull driver and the LP receiver is an un-terminated, single-ended receiver (i.e. in low-power mode all wires are operated in a single-ended and un-terminated manner).
- The LP-CD function is only required for bi-directional operation.
- Low-power functions are always present in pairs as these are single-ended functions operating on each of the two interconnect wires individually forming a high-speed differential pair.
- Presence of high-speed and low-power functions is correlated. That is, if a lane module contains a HS-TX, then it shall also contain a LP-TX. A similar constraint holds for HS-RX and LP-RX.

Transmitter functions define the lane state by driving certain line levels and employing four discrete signal levels: HS-High and HS-Low in red and LP-High and LP-Low in blue as depicted in Figure 3.

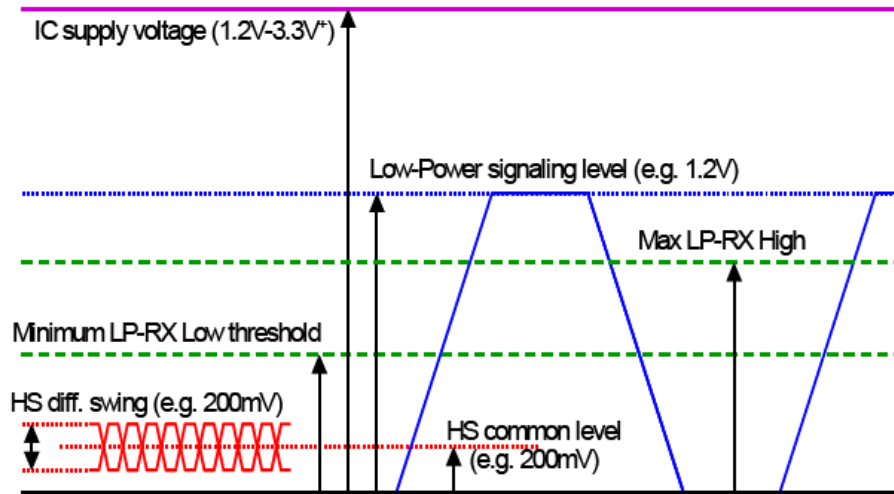


Figure 3: D-PHY signal levels ^[2]

During normal operation, either a HS-TX or a LP-TX is driving a lane. A HS-TX always drives the lane differentially while the two LP-TXs drive larger swing signals through the two lines of the lane independently in a single-ended manner. This results in two possible high-speed lane states as well as four possible low-power lane states. The high-speed lane states are differential-0 and differential-1, while the lane states of low-power signals are represented as LP-00, LP-01, LP-10 and LP-11 as shown in Table 1. Low-power signaling is used for both Control mode and Escape mode. These modes will further play a role in a higher protocol layer related to the state machine. The interpretation of low-power lane states depends on the mode of operation. The low-power receivers will always interpret both high-speed differential states as LP-00. This can be guaranteed by MIPI's implementation of setting the maximum high-speed signal level below the threshold of low-power logic zero from the receiver side.

Consequently, these coded states are used to drive a sophisticated state machine in the higher protocol layer to determine the MIPI operation. For example, the sequence to switch into high-speed mode from low-power mode is: LP-11, LP-01, LP-00, and then the data lane remains in high-speed mode until another LP-11 is received.

State Code	Line Voltage Levels		High-Speed	Low-Power	
	Dp-Line	Dn-Line	Burst Mode	Control Mode	Turn-around or Escape Mode
HS-0	HS Low	HS High	Differential-0	1	1
HS-1	HS High	HS Low	Differential-1	1	1
LP-00	LP Low	LP Low	N/A	Bridge	Space
LP-01	LP Low	LP High	N/A	HS-Rqst	Mark-0
LP-10	LP High	LP Low	N/A	LP-Rqst	Mark-1
LP-11	LP High	LP High	N/A	Stop	2

Table 1: D-PHY lane state descriptions ^[2]

The clock lane mode is controlled by the protocol via the clock lane PHY Protocol Interface (PPI). The protocol makes sure that a lane is in high-speed mode only during high-speed data transmission. In contrast, the low-power transmission drives all the lines in low-power operating modes in order to suppress the static power consumption, which is important for mobile applications. Note that within the scope of the D-PHY specification, besides serialization and de-serialization, no additional coding scheme is specified.

3. MIPI D-PHY test challenges and solutions

While the D-PHY physical layer specification enables significant extension flexibility and employs different modes to reduce power consumption, it also leads to big test challenges for device manufacturers.

During D-PHY's receiver test, the high-speed data transmission, which typically runs within the range of 1000 Mbps, is what we are most concerned with. In this speed range, tests up to 800 Mbps can be covered by V93000 Pin Scale 800 cards. The Pin Scale 3600 card, in standard mode, is able to fulfil the speed requirements above 800 Mbps as shown in Figure 4.

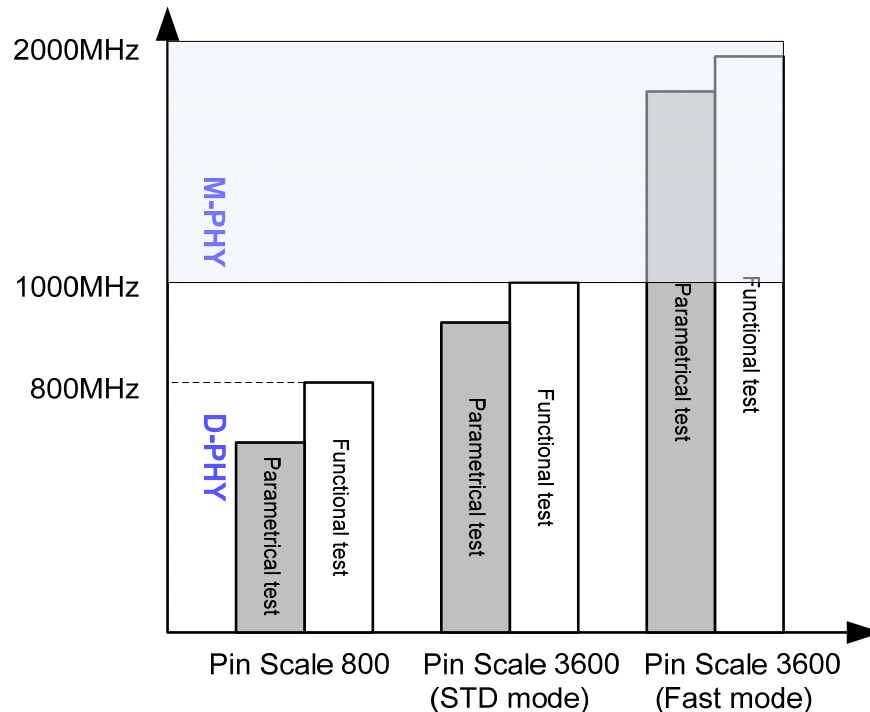
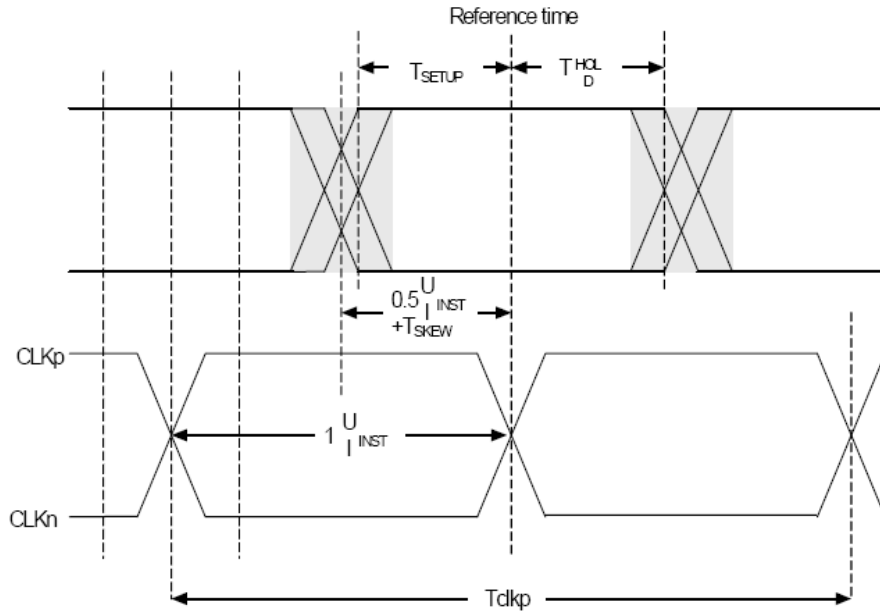


Figure 4: Pin Scale solution for MIPI testing

First of all, for MIPI transmitter tests, it is the source-synchronous nature of the high-speed data transmission, which represents a challenge for most ATE. With data transmission speeds approaching Gbits per second, the common mode phase of both the forwarded clock and data potentially not only show some static timing offset (i.e. latency which might change from device to device, lot to lot, etc.), but also dynamic effects such as common drift and relative jitter.

The need for a source synchronous measurement is addressed with Verigy's Pin Scale system by its unique "multiple fixed phase capture and compare methodology". For more details on source-synchronous testing method, please refer to the VOICE 2006 conference paper "A Flexible and Scalable Methodology for Testing High Speed Source Synchronous Interfaces on ATE with Multiple Fixed Phase Capture and Compare".^[5]



Parameter	Symbol	Min	Typ	Max	Units
Nominal long term average frequency	f_{AV}	40		$f_{h_{MAX}}$	MHZ
UI instaneous	UI_{INST}	0.8		1.2	UI_{NOM}
Data to clock skew [Tx]	$T_{SKEW}[Tx]$	-0.075		0.075	UI_{NOM}
Data to clock setup time [Rx]	$T_{SETUP}[Rx]$	0.15			UI_{NOM}
Clock to data hold time [Rx]	$T_{HOLD}[Rx]$	0.15			UI_{NOM}

Figure 5: D-PHY forward high-speed data to clock timing ^[2]

For receiver testing, it is mainly the demand of providing multi-level signals to the DUT, which represents an additional challenge for ATE. This is especially true, since the economic pressure in the consumer electronics marketplace rules out the use of special tester hardware beyond standard digital pins. In contrast to most available commodity ATE pin electronic cards, all standard V93000 Pin Scale digital cards address this challenge with their ability to easily generate multiple digital levels.

The V93000 Pin Scale system provides 16 edges per pin (i.e. eight drive and eight receive edges). All the drive edges are tri-state enabled. Each pin can operate as either a single-ended or differential pin, because of the pseudo-differential driver structure of the Pin Scale card. Therefore, we adopt the "1" and "0" levels generated by a pair of differential channels of a Pin Scale 800, or Pin Scale 3600 standard mode, to provide the corresponding signal levels of the differential high-speed data. As each pin is an I/O pin, a Pin Scale system also enables transmitter/receiver switching for data transmission in "forward direction" or "reverse traffic" within a pattern.

In addition, since the level difference between high-speed logic "0" and low-power logic "0" is rather small and thus can be neglected, the same (programmed) low level is used to express the logic "0" of the low-power signal. As a result, the number of distinct signaling levels to be generated can be reduced to three.

In order to generate logic "1" of the low-power signal, a third level is available via tri-state, referred to as V_T in Figure 6. As the maximum data rate is only 10 Mbps in low-power mode, there is no need to be concerned with speed issues.

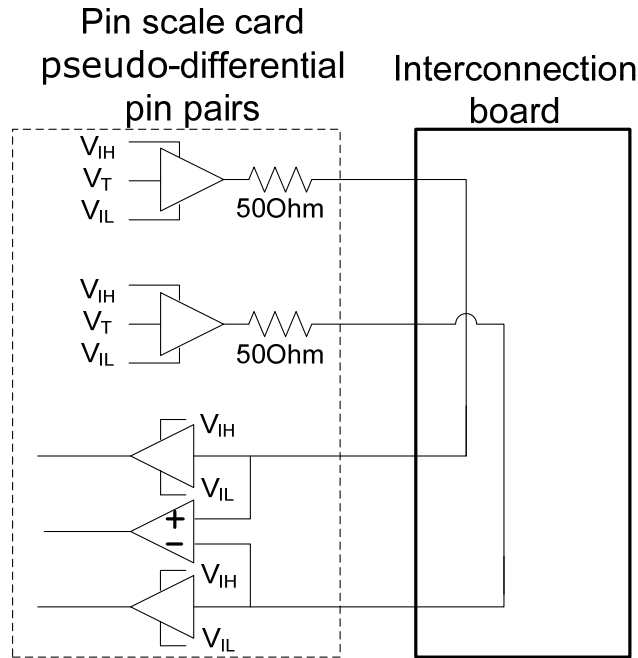


Figure 6: MIPI D-PHY test demo configuration

As a result, the MIPI multi-level signaling can be generated as in Figure 7. The low-frequency, low-power signal is achieved with a repeat instruction to spread out a certain high-speed pattern. For the demonstration setup depicted in Figure 6, we use a data rate of 400 Mbps.

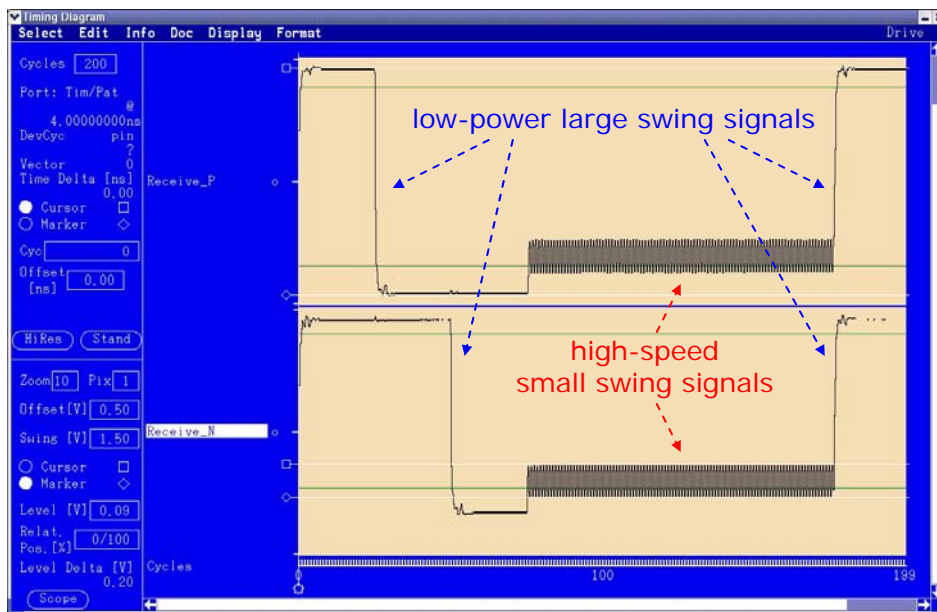


Figure 7: Multi-level signaling in timing diagram

When zooming in closer, we find that the positive low-power level is not perfectly aligned as shown in Figure 8. This is due to the intrinsic switching delay between the ordinary level and the third level. Such delay is a typical intermitting feature of standard three-level drivers determined by hardware. As a consequence, the delay of third level switching suppresses the following bits as illustrated in Figure 9.

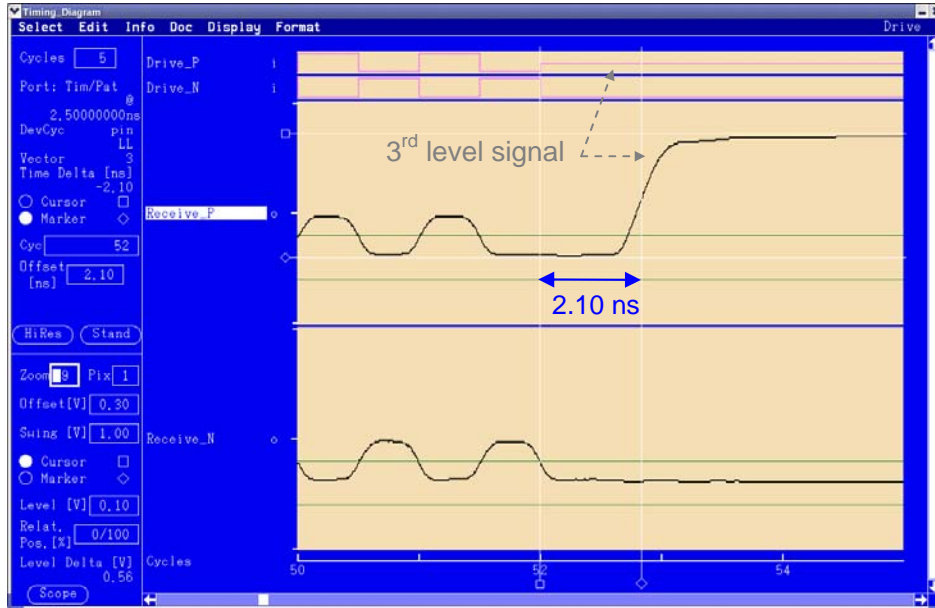


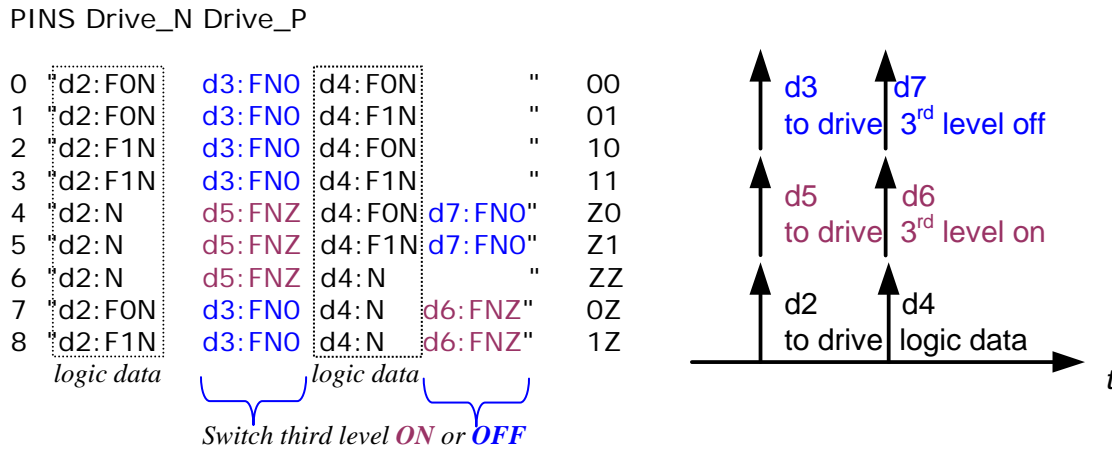
Figure 8: Intrinsic delay (2.10 ns) of third level on



Figure 9: Intrinsic delay (1.92 ns) of third level off

In order to eliminate such misalignment, first of all, different drive edges should be chosen for data and third level edges. Second, as observed from Figure 8 and Figure 9, the intrinsic delay for entering the third level differs from the one for exiting the third level. Consequently, two dedicated edges are required for third level on and off respectively. ^[4] For example, edge d2 and

d4 are chosen for data-driving actions, d5, d6 for driving third level on, and d3 for third level off, and the waveform table is defined as following an example for "X2 mode". Furthermore, it is worthwhile noticing that d2, d3 and d5 are triggering drive edge at exactly the same time.



Since the amount of timing misalignment is not fixed across different pins, it needs to be measured independently on a per-pin basis. For this, it is convenient to use a clean transition from low-power logic one (in either high-speed or low-power mode) to logic zero as shown in Figure 9. Note that the delay for both switching the third level on and off are pin characteristics and thus must be measured (i.e. only once during the first execution of test-flow).

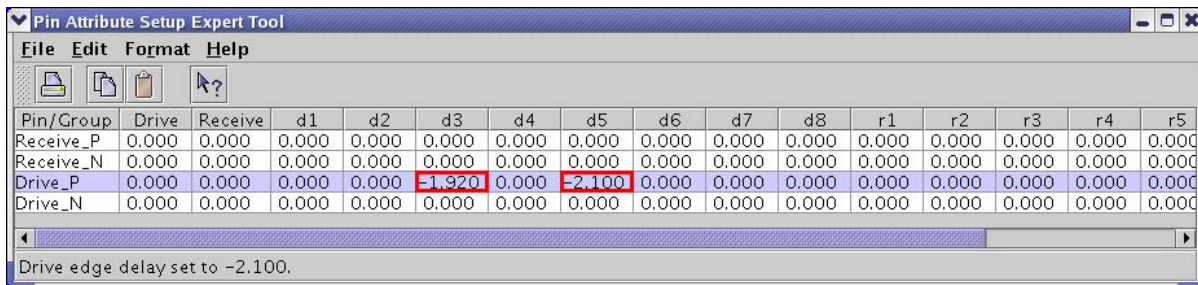


Figure 10: Intrinsic delay compensation via Pin Attributes

Finally, in order to compensate for the intrinsic delay, third level driving edges are shifted earlier in time. In practice, this is done by programming the measured difference value into the pin attributes to calibrate out the intrinsic delay on a per-pin and per-edge basis as Figure 10 indicates. The values entered are taken into consideration by SmarTest, and as a result, perfect aligned timing can be observed as shown in Figure 11 and 12.

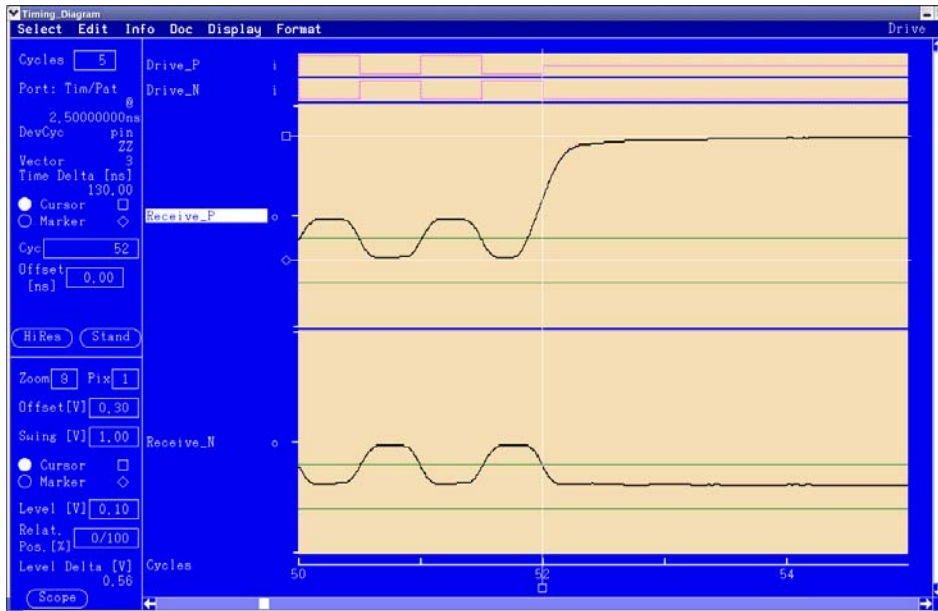


Figure 11: Third level *on* after compensation

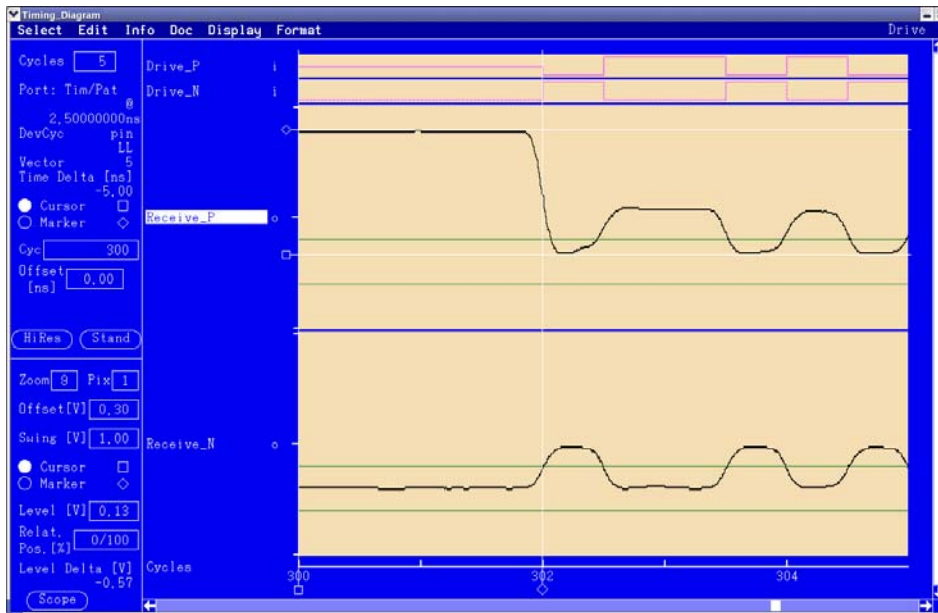


Figure 12: Third level *off* after compensation

As characteristics of the pin electronics, the intrinsic delays have been proven to be edge independent; therefore user can have full flexibility to choose edges among the eight driving edges for driving the third level. In addition, the intrinsic delay is frequency independent, but closely related to the voltage swing (i.e. larger swings lead to longer intrinsic delays). For practical convenience, a test method, shown in Figure 13, has been developed, which measures and compensates for the third level switching delay automatically.

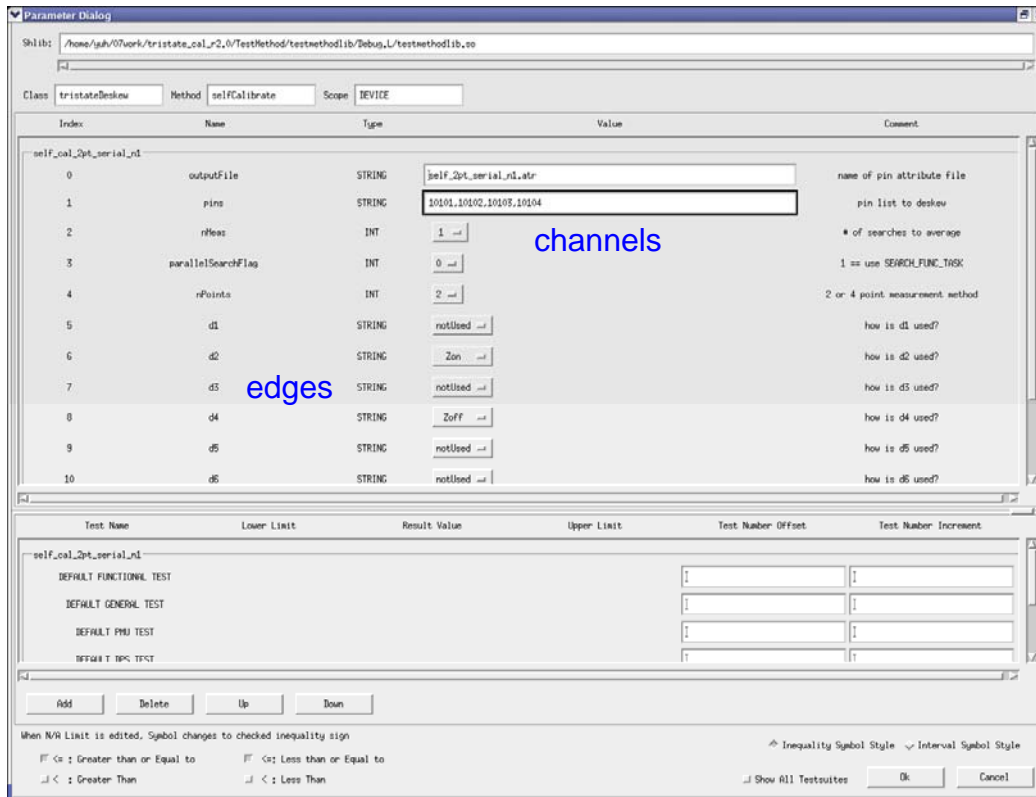


Figure 13: Test Method for third level switching delay auto-compensation

4. Conclusion

MIPI D-PHY is an increasingly popular low-power, low-cost, high-speed serial interface for mobile applications processors. It is a common interface that encompasses displays, cameras, memory in smart phones, PDAs and other devices. For testing aspects, this paper has focused on receiver test of the D-PHY layer.

The V93000 Pin Scale 800, or Pin Scale 3600 standard mode, is capable of solving all the challenges introduced by MIPI D-PHY testing, such as high-speed data transmission, source synchronous testing and multi-level signaling. This paper mainly addresses the D-PHY receiver test and explains how to generate three distinct levels by employing a third level voltage with appropriate delay compensation.

5. Acknowledgements

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6. References

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